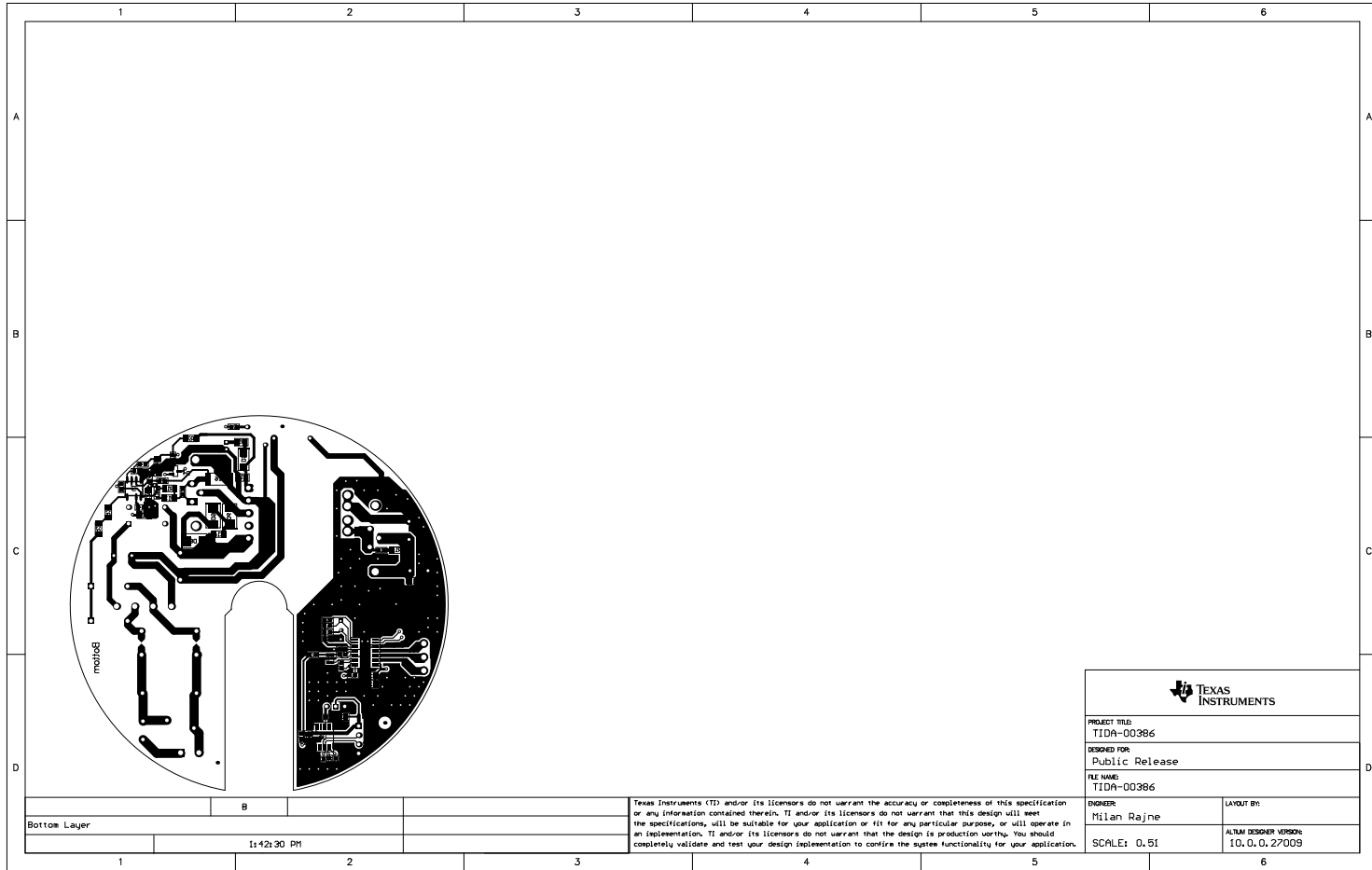



Z21 #Internal label, in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
 Z22 #These assemblies are ESD sensitive, ESD precautions shall be observed.
 Z23 #These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
 Z24 #These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

PCB VIEWED FROM TOP SIDE
 Top Layer
 1:42:29 PM

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PROJECT TITLE: TIDA-00386	
DESIGNED FOR: Public Release	
FILE NAME: TIDA-00386	
DESIGNER: Milan Rajne	LAYOUT BY:
SCALE: 0.51	ALTUM DESIGNER VERSION: 10.0.0.27009



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Bottom Layer		1:42:30 PM	
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